



Dual N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY

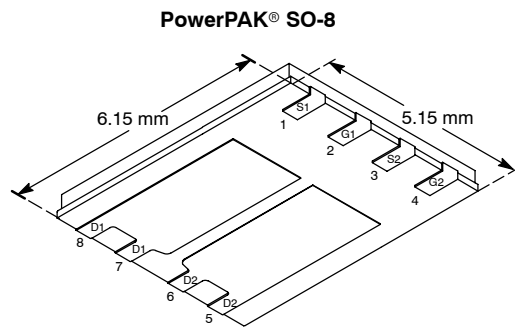
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
60	0.075 @ $V_{GS} = 10$ V	4.6
	0.100 @ $V_{GS} = 4.5$ V	4.0

FEATURES

- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package
- Dual MOSFET for Space Savings

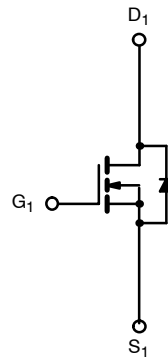
APPLICATIONS

- Automotive
 - ABS
 - Coil Driver
 - Load Switch

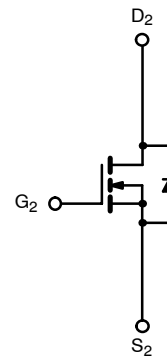


Bottom View

Ordering Information: Si7948DP-T1



N-Channel MOSFET



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	60		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 25°C	I _D	4.6	3.0	A
	T _A = 70°C		3.6	2.4	
Pulsed Drain Current		I _{DM}	15		
Continuous Source Current (Diode Conduction) ^a		I _S	2.7	1.2	
Single Avalanche Current	L = 0.1 mH	I _{AS}	15		
Single Avalanche Energy		E _{AS}	11		mJ
Maximum Power Dissipation ^a	T _A = 25°C	P _D	3.3	1.4	W
	T _A = 70°C		2.1	0.9	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 10$ sec	R_{thJA}	29	38	$^\circ\text{C/W}$
	Steady State		60	85	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	4.0	5.2	

Notes

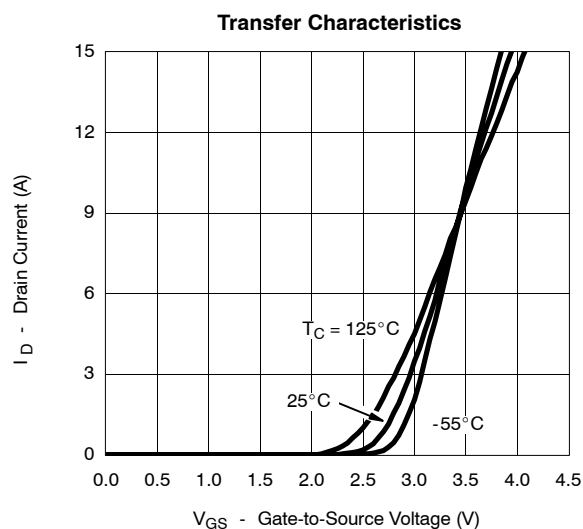
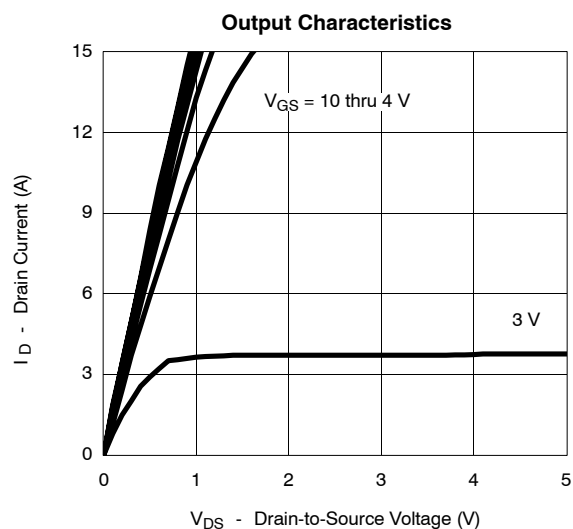
a. Surface Mounted on 1" x 1" FR4 Board.

SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	1		3	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 20\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60\ \text{V}$, $V_{GS} = 0\ \text{V}$			1	μA
		$V_{DS} = 60\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 55^\circ\text{C}$			5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\ \text{V}$, $V_{GS} = 10\ \text{V}$	15			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10\ \text{V}$, $I_D = 4.6\ \text{A}$		0.060	0.075	Ω
		$V_{GS} = 4.5\ \text{V}$, $I_D = 4.0\ \text{A}$		0.080	0.100	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\ \text{V}$, $I_D = 4.6\ \text{A}$		6		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.7\ \text{A}$, $V_{GS} = 0\ \text{V}$		0.8	1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 30\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 15\ \text{A}$		12	20	nC
Gate-Source Charge	Q_{gs}			2		
Gate-Drain Charge	Q_{gd}			3.5		
Gate Resostance	R_g			1.5		Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 30\ \text{V}$, $R_L = 2\ \Omega$ $I_D \approx 15\ \text{A}$, $V_{GEN} = 10\ \text{V}$, $R_G = 2.5\ \Omega$		7	20	ns
Rise Time	t_r			8	25	
Turn-Off Delay Time	$t_{d(off)}$			15	40	
Fall Time	t_f			7	20	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 2.7\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$		30	60	

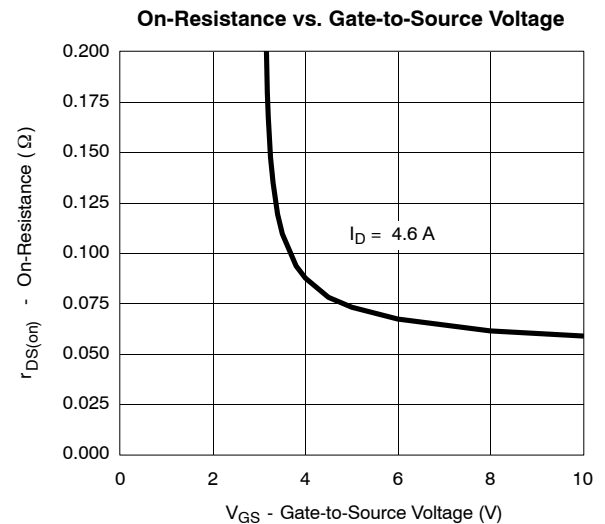
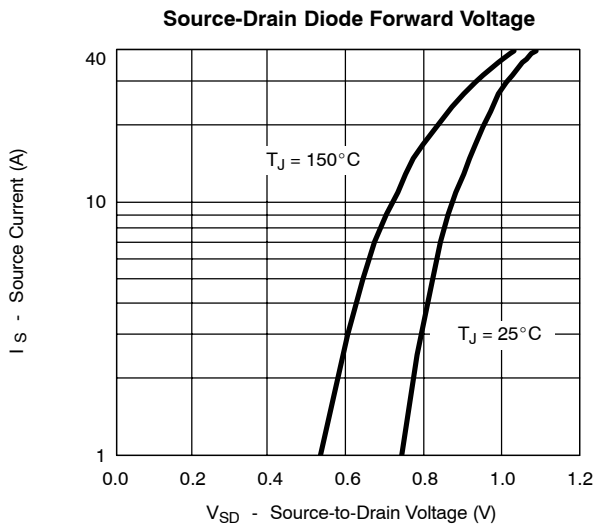
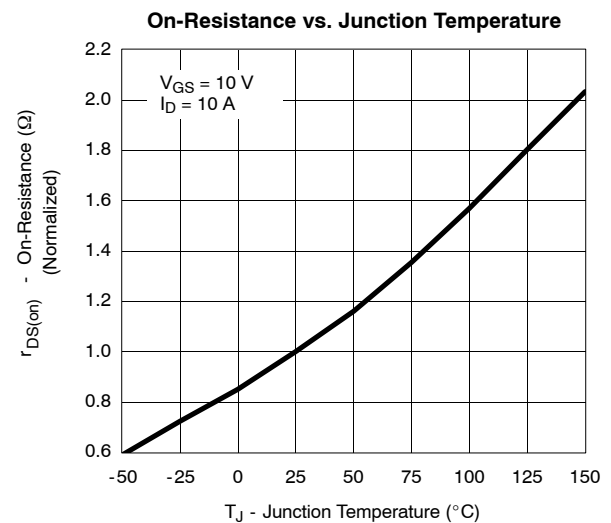
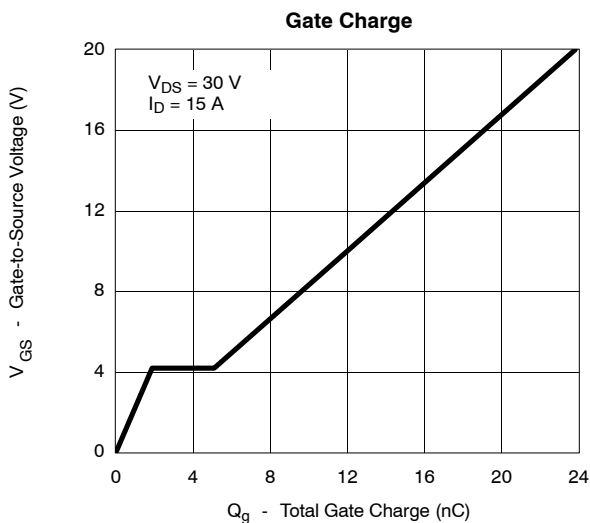
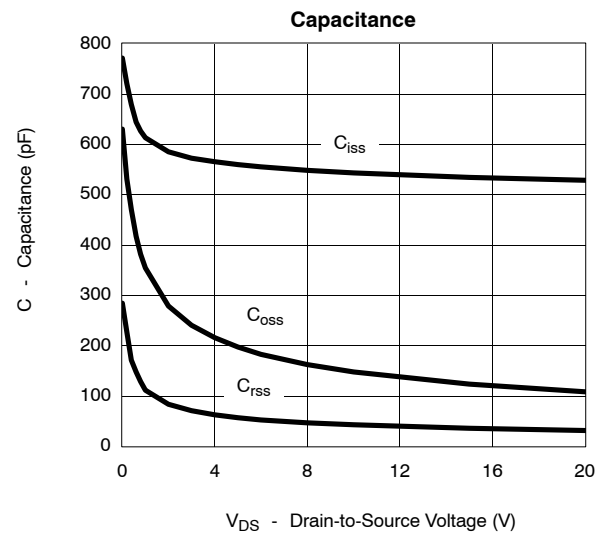
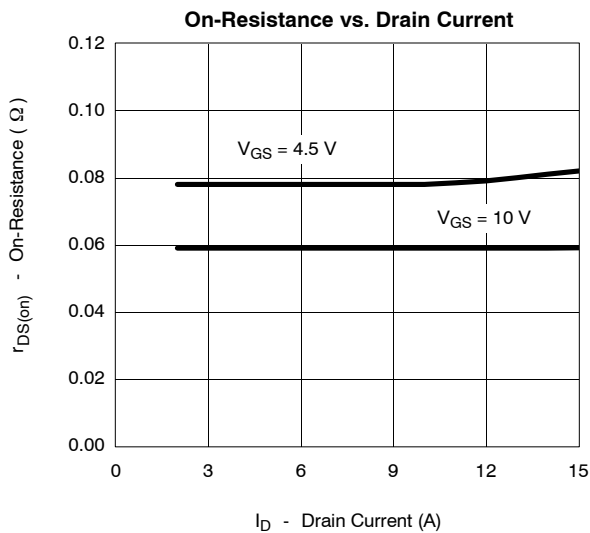
Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

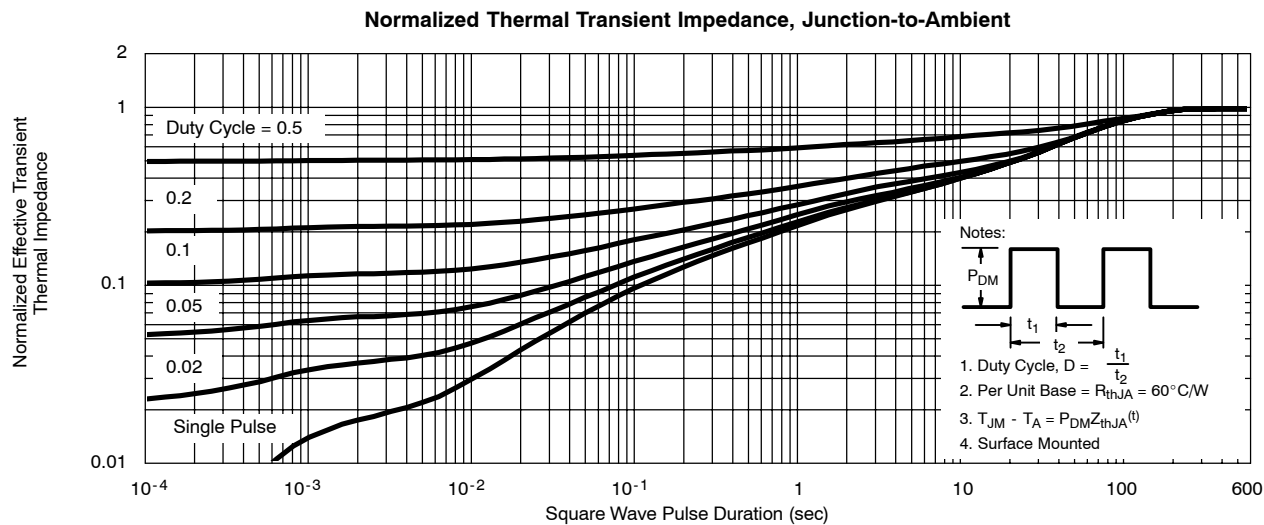
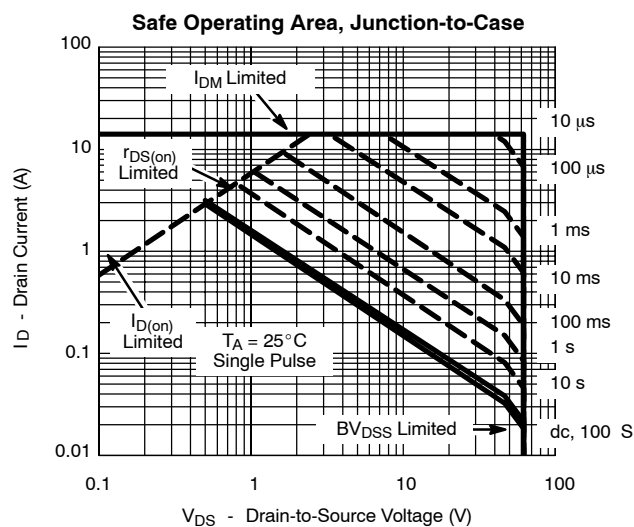
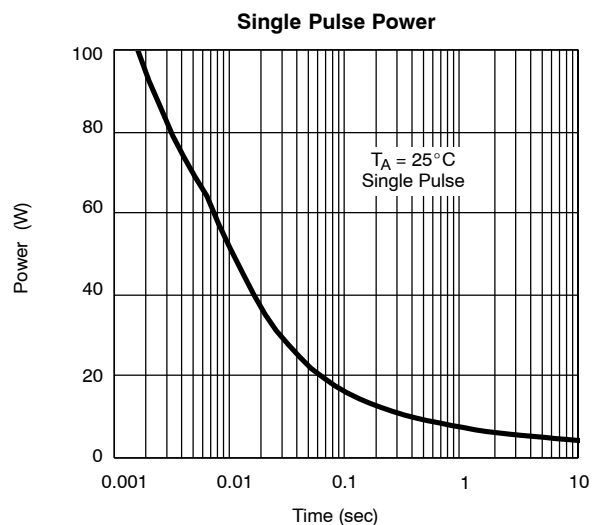
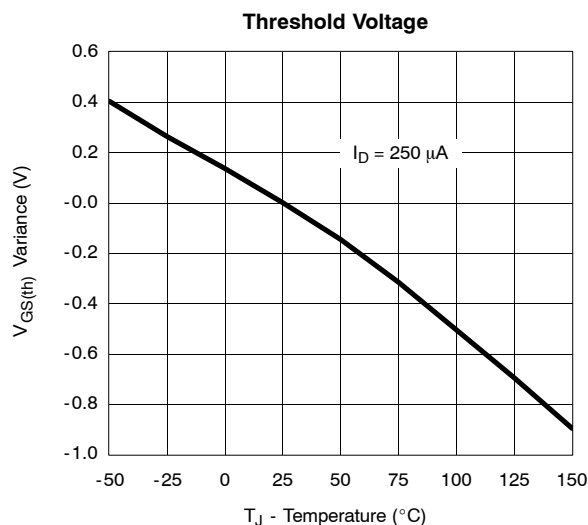
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



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